

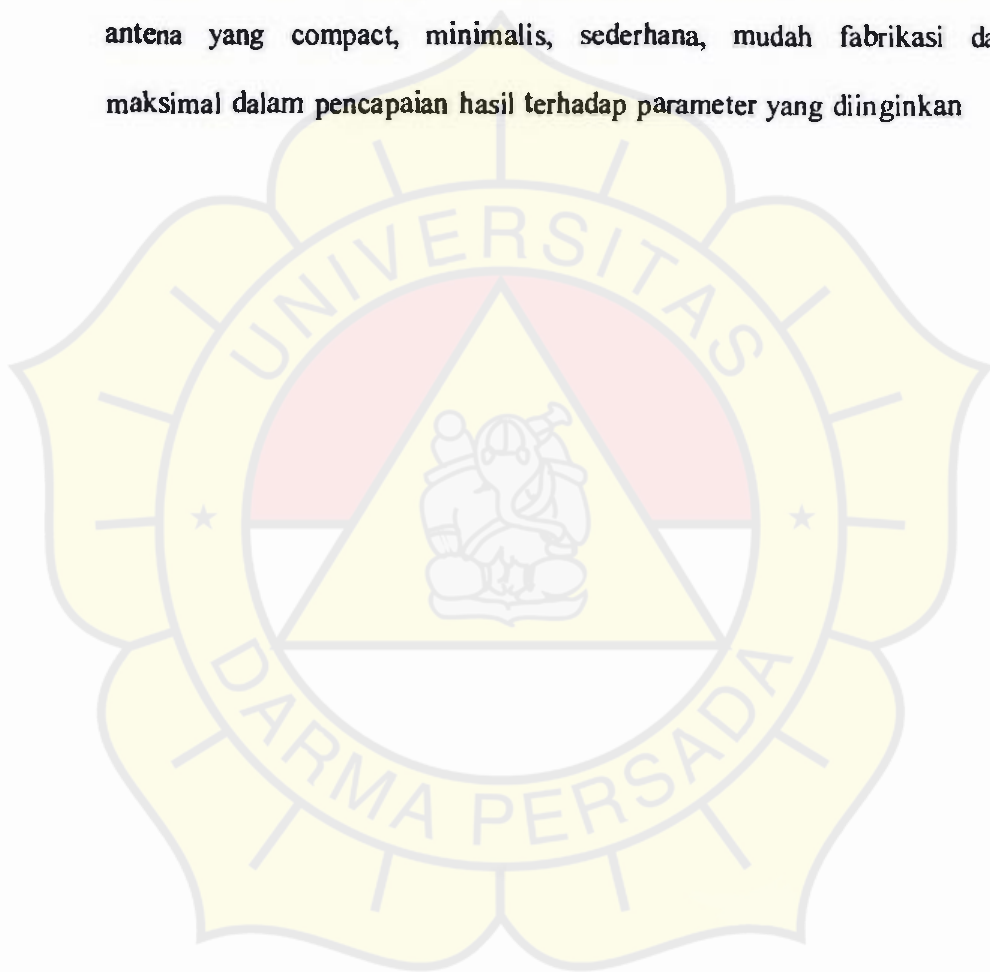
## BAB V

### KESIMPULAN

1. Dari hasil perancangan antenna untuk frekuensi operasi Wifi 2,4 s.d 2,5 GHz diperoleh target dari parameter yang diperoleh dari hasil simulasi dan pengukuran. Parameter hasil simulasi maupun pengukuran untuk parameter S11 antara lain : Return Loss dibawah 10 dB dari hasil simulasi didapat 13,99- 18,83 dB dan dari hasil pengukuran didapat 10,121 – 14,503. VSWR untuk nilai min s.d maks dari simulasi didapat dari 1,687 – 1,72 dan dari pengukuran didapat dari 1,4623 – 1,9174. Untuk target resonansi di daerah frekuensi *center* 2,45 GHz dari hasil simulasi dan pengukuran diperoleh penyimpangan atau pergeseran frekuensi resonansi sebesar 0,73%. Impedansi masukan dari hasil proses simulasi 49,04  $\Omega$  dan hasil pengukurannya 58,57 + j1,4536  $\Omega$ .
2. Karakteristik antenna bersifat Monopole dari hasil polaradiasi dengan maksimum directivity diperoleh gain 6,42 dB dengan lebar Beamwidth 85,02°. Dari hasil rancang bangun antenna mikrostrip patch bujur sangkar dengan struktur planar menggunakan saluran microstrip mempunyai polarisasi linear
3. Penambahan sebuah stub seri sebagai *transformer matching* impedansi diperoleh efektif diletakan dengan panjang 0,162  $\lambda_g$  dan ditempatkan pada

posisi jarak dari patch  $0.081 \lambda_g$ . Kondisi ini diperoleh dari parameter yang didapat dari S11. Penggunaan *Stub line* memberikan kondisi *matching* yang diharapkan sehingga dapat untuk meng-eliminasi refleksi akibat perbedaan impedansi beban dengan impedansi gelombang.

4. Protoype antena mikrostrip memperlihatkan sebuah rancang bangun antena yang compact, minimalis, sederhana, mudah fabrikasi dan maksimal dalam pencapaian hasil terhadap parameter yang diinginkan



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# **LAMPIRAN 1**

**Spesifikasi Substrate**



Advanced Circuit Materials Division  
480-961-1382 FAX: 480-961-4533  
www.rogerscorporation.com

### High Frequency Laminates: Standard Thickness, Tolerance and Panel Sizes

Grade	Dielectric Constant	Standard Dielectric Thickness	Standard Panel Sizes
RT/duroid® 5870 RT/duroid 5880	2.33 2.20	0.005" (0.127mm) ±0.0005" 0.010" (0.254mm) ±0.0007" 0.015" (0.381mm) ±0.001" 0.020" (0.508mm) ±0.001" 0.031" (0.787mm) ±0.001" 0.062" (1.570mm) ±0.002" 0.125" (3.170mm) ±0.004"	18" X 12" (457 X 305mm) 18" X 24" (457 X 605mm) 18" X 36" (457 X 914mm) 18" X 48" (457 X 1219mm)
RT/duroid 5880L2	1.96	0.010" (0.254mm) ±0.001" 0.020" (0.508mm) ±0.001" 0.025" (0.625mm) ±0.001" 0.030" (0.762mm) ±0.002" 0.040" (1.026mm) ±0.002" 0.050" (1.270mm) ±0.003" 0.100" (2.540mm) ±0.004" Other thicknesses available in 10 mil increments.	12" X 18" (305 X 457mm) 24" X 18" (610 X 457mm) 24" X 54" (610 X 1370mm)
RT/duroid 6002 *RT/duroid 6202	2.94 *2.90 (0.005") *2.98 (0.010") *3.00 (0.015") *2.90 (0.020/0.030)	0.005" (0.127mm) ±0.0005" 0.010" (0.254mm) ±0.0007" 0.020" (0.508mm) ±0.001" 0.030" (0.762mm) ±0.0015" 0.060" (1.524mm) ±0.002" 0.120" (3.048mm) ±0.004"	12" X 18" (305 X 457mm) 24" X 18" (610 X 457mm) 24" X 54" (610 X 1370mm)
RT/duroid 6006	4.15	0.010" (0.254mm) ±0.001"	10" X 10" (254 X 254mm)
RT/duroid 6010LM	10.2 10.5 10.8	0.025" (0.625mm) ±0.001" 0.050" (1.270mm) ±0.002" 0.075" (1.905mm) ±0.004" 0.100" (2.540mm) ±0.005"	10" X 20" (254 X 508mm) 20" X 20" (508 X 508mm) 18" X 12" (457 X 305mm) 18" X 24" (457 X 605mm)
RT/duroid material available claddings: 1/4 oz. (9µm), 1/2 oz. (17µm), 1 oz. (35µm), 2 oz. (70µm) electrodeposited copper foil; 1/2 oz. (17µm), 1 oz. (35µm), 2 oz. (70µm) rolled copper foil. Thick metal cladding on aluminum, brass and copper are available.			
TMM83	3.27	0.015" (0.381mm) ±0.0015" 0.020" (0.508mm) ±0.0015" 0.030" (0.762mm) ±0.0015" 0.060" (1.524mm) ±0.0015" 0.125" (3.175mm) ±0.0015"	18" X 12" (457 X 305mm) 18" X 24" (457 X 610mm)
TMM4	4.50	0.015" (0.381mm) ±0.0015" 0.025" (0.635mm) ±0.0015" 0.050" (1.270mm) ±0.0015" 0.075" (1.905mm) ±0.0015" 0.100" (2.540mm) ±0.0015"	
TMM6	6.00		
TMM10	9.20		
TMM10i	9.80		
TMM13i	12.80		
TMM material available claddings: 1/4 oz. (9µm), 1/2 oz. (17µm), 1 oz. (35µm), 2 oz. (70µm) electrodeposited copper foil. Thick metal cladding on aluminum and brass are available.			
ULTRALAM® 2000	2.40 2.45 2.48 2.50 2.55	0.004" (0.102mm) ±0.0004 0.0101" (0.257mm) ±0.009 0.0147" (0.373mm) ±0.001 0.0190" (0.483mm) ±0.001 0.0300" (0.762mm) ±0.001	18" X 12" (457 X 305mm) 18" X 24" (457 X 610mm) 18" X 36" (457 X 915mm) 18" X 48" (457 X 1219mm)
ULTRALAM 2000 material available claddings: 1/4 oz. (9µm), 1/2 oz. (17µm), 1 oz. (35µm), 2 oz. (70µm) electrodeposited copper foil; 1/2 oz. 1 oz. and 2 oz. rolled copper foil. Thick metal cladding on aluminum, brass and copper are available.			



Grade	Dielectric Constant	Standard Dielectric Thickness	Standard Panel Sizes
RO3003™	3.00	0.005" (0.13mm) ± 0.0005 0.010" (0.25mm) ± 0.0007 0.020" (0.50mm) ± 0.001	12" X 18" (305 X 457mm) 24" X 18" (610 X 457mm) 24" X 36" (610 X 915mm)
RO3005™	3.5	0.030" (0.75mm) ± 0.0015 0.060" (1.52mm) ± 0.003	
RO3006™	3.75	0.005" (0.13mm) ± 0.0005 0.010" (0.25mm) ± 0.0007	
RO3010™	10.2	0.025" (0.64mm) ± 0.001 0.050" (1.27mm) ± 0.002	
RO3203™	3.02	0.010" (0.25mm) ± 0.0007 0.020" (0.50mm) ± 0.001 0.030" (0.75mm) ± 0.0015 0.060" (1.52mm) ± 0.003	
RO3205™	3.75	0.025" (0.64mm) ± 0.001	
RO3210™	10.2	0.050" (1.27mm) ± 0.002	
FR-4XX series materials are available in 1/4mm (0.039") or 1/2mm (0.078") electrodeposited copper foil.			
RO4003™ RO4300™	3.35 3.15	0.005" (0.25mm) ± 0.0010 0.012" (0.305mm) ± 0.0010 0.020" (0.508mm) ± 0.0015 0.030" (0.762mm) ± 0.0015 0.032" (0.813mm) ± 0.0020 0.060" (1.524mm) ± 0.0040	12" X 18" (305 X 457mm) 24" X 18" (610 X 457mm) 24" X 36" (610 X 915mm) 48" X 36" (1224 X 915mm)
RO4350B™	3.45	0.006" (0.155mm) ± 0.0007 0.010" (0.25mm) ± 0.0010 0.020" (0.508mm) ± 0.0015 0.036" (0.914mm) ± 0.0015 0.050" (1.27mm) ± 0.0020 0.060" (1.52mm) ± 0.0040	
RO4450 B PREPREG	3.20	0.006" (0.15mm)	24" X 18" (610 X 457mm)
	3.54	0.004" (0.102mm)	
RO4450F PREPREG	3.52	0.004" (0.102mm)	24" X 18" (610 X 457mm)

Grade	Dielectric Constant	Standard Dielectric Thickness	Standard Panel Sizes
RO6760 Antenna Grade	3.00	0.030 (0.762mm) ± 0.0015 0.060 (1.524mm) ± 0.003	24" X 18" (610mm X 457mm) 24 X 54" (610mm X 1.37m)
RO4760 Antenna Grade	3.00	0.0307 (0.780mm) ± 0.015 0.0407 (1.034mm) ± 0.002 0.0607 (1.542mm) ± 0.003	24 X 18 (610 X 457mm) 48 X 36" (1224mm X 915mm)

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The logo of Universitas Darma Persada is a large, light yellow emblem with a scalloped border. It features a central shield with a red upper half and a white lower half. Inside the shield is a white figure of a person riding a horse. The shield is set against a background of a yellow triangle. The words "UNIVERSITAS" and "DARMA PERSADA" are written in a circular path around the shield, with two small stars on either side.

# **LAMPIRAN 2**

**Wifi Standar**



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## Introduction to Wi-Fi (802.11)

The IEEE 802.11 specification (ISO/IEC 8802-11) is an international standard describing the characteristics of a wireless local area network (WLAN). The name Wi-Fi (short for "Wireless Fidelity" sometimes incorrectly shortened to WiFi) corresponds to the name of the certification given by the WiFi Alliance formerly WEGA (Wireless Ethernet Compatibility Alliance) the group which ensures compatibility between hardware devices that use the 802.11 standard. Today due to misuse of the terms (and for marketing purposes) the name of the standard is often confused with the name of the certification. A Wi-Fi network in reality is a network that complies with the 802.11 standard. Hardware devices certified by the Wi-Fi Alliance are allowed to use this logo

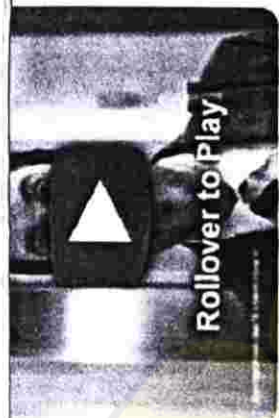


With Wi-Fi, it is possible to create high-speed wireless local area networks, provided that the computer to be connected is not too far from the access point. In practice, Wi-Fi can be used to provide high-speed connections (11 Mbps or greater) to laptop computers, desktop computers, personal digital assistants (PDAs) and any other devices located within a radius of several dozen metres indoors (in general 20m-50m away) or within several hundred metres outdoors.

WiFi providers are starting to blanket areas that have a high concentration of users (like train stations, airports, and hotels) with wireless networks. These access areas are called "hot spots".

## Introduction to Wi-Fi (802.11)

The 802.11 standard reserves the low levels of the OSI model for a wireless connection that uses



Exclusive interview for Kioske

**Paul Hermelin (CEO, Capgemini) : "We expect to join the top 10 in the US soon"**

50m away) or within several hundred metres outdoors

Wi-Fi providers are starting to blanket areas that have a high concentration of users (like train stations, airports, and hotels) with wireless networks. These access areas are called "hot spots".

### Introduction to Wi-Fi (802.11)

The 802.11 standard reserves the low levels of the OSI model for a wireless connection that uses electromagnetic waves i.e.

- The physical layer (sometimes shortened to the "PHY" layer) which offers three types of information encoding
- The data link layer, composed of two sub-layers: Logical Link Control (or LLC) and Media Access Control (or MAC)

The physical layer defines the radio wave modulation and signalling characteristics for data transmission while the data link layer defines the interface between the machine's bus and the physical layer in particular an access method close to the one used in the Ethernet standard and rules for communication between the stations of the network. The 802.11 standard actually has three physical layers which define alternative modes of transmission

Data Link Layer (MAC)	802.2	
	802.11	
Physical Layer (PHY)	DSSS	Infrared

Any high-level protocol can be used on a Wi-Fi wireless network the same way it can be used on an Ethernet network

### The various Wi-Fi standards

The IEEE 802.11 standard is actually only the earliest standard allowing 1.2 Mbps of bandwidth. Amendments have been made to the original standard in order to optimise bandwidth. These include the 802.11g, 802.11n and 802.11ac standards which are called 802.11 physical standards or to better specify



Any high-level protocol can be used on a WiFi wireless network the same way it can be used on an Ethernet network.

### The various Wi-Fi standards

The IEEE 802.11 standard is actually only the earliest standard allowing 1-2 Mbps of bandwidth. Amendments have been made to the original standard in order to optimise bandwidth (these include the 802.11a, 802.11b and 802.11g standards which are called 802.11 physical standards) or to better specify components in order to ensure improved security or compatibility. This table shows the various amendments to the 802.11 standard and their significance.

Name of standard	Name	Description
802.11a	WiFi5	The 802.11a standard (called WiFi 5) allows higher bandwidth (54 Mbps maximum throughput 30 Mbps in practice). The 802.11a standard provides 8 radio channels in the 5 GHz frequency band.
802.11b	WiFi	The 802.11b standard is currently the most widely used one. It offers a maximum throughput of 11 Mbps (6 Mbps in practice) and a reach of up to 300 metres in an open environment. It uses the 2.4 GHz frequency range with 3 radio channels available.
802.11c	Bridging 802.11 and 802.1d	The 802.11c bridging standard is of no interest to the general public. It is only an amended version of the 802.1d standard that lets 802.1d bridge with 802.11-compatible devices (on the data link level).
802.11d	Internationalisation	The 802.11d standard is a supplement to the 802.11 standard which is meant to allow international use of local 802.11 networks. It lets different devices trade information on frequency ranges depending on what is permitted in the country where the device is from.



Introduction to Wi-Fi (802.11 or WiFi) - Windows Internet Explorer

http://en.kioska.net/contents/wifi/wifiintro.php3

Introduction to Wi-Fi 8... X

KOMPAS.com

Introduction to Wi-Fi 8... X

802.11e	Improving service quality	The 802.11e standard is meant to improve the quality of service at the level of the data link layer. The standard's goal is to define the requirements of different packets in terms of bandwidth and transmission delay so as to allow better transmission of voice and video.
802.11f	Roaming	The 802.11f is a recommendation for access point vendors that allows products to be more compatible. It uses the Inter-Access Point Roaming Protocol, which lets a roaming user transparently switch from one access point to another while moving around, no matter what brands of access points are used on the network infrastructure. This ability is also simply called <i>roaming</i> .
802.11g		The 802.11g standard offers high bandwidth (54 Mbps maximum throughput, 30 Mbps in practice) on the 2.4 GHz frequency range. The 802.11g standard is backwards-compatible with the 802.11b standard, meaning that devices that support the 802.11g standard can also work with 802.11b.
802.11h		The 802.11h standard is intended to bring together the 802.11 standard and the European standard (HiperLAN/2 hence the h in 802.11h), while conforming to European regulations related to frequency, use and energy efficiency.
802.11i		The 802.11i standard is meant to improve the security of data transfers (by managing and distributing keys and implementing encryption and authentication). This standard is based on the AES (Advanced Encryption Standard) and can encrypt transmissions that run on 802.11a, 802.11b and 802.11g technologies.
802.11r		The 802.11r standard has been elaborated so that it may use infrared signals. This standard has become

← ↑

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start | Macro... | 2 Word... | AutoCA... | CE-200... | SU-100... | Introduc... | Wifi stan... | WPA | ESC | Wifi stan... | 5:37 AM

## CURICULUM VITAE

Nama : Gun Gun Gundalih Permadi  
Tempat/Tanggal Lahir : Sukabumi, 19 September 1975  
Jenis Kelamin : Laki-laki  
Agama : Islam  
Status : Menikah  
Alamat : Vila Indah Permai, Blok 14 no.2, Teluk Pucung,  
Bekasi Utara  
Telepon : 0812 9699 519  
Email : gungun.gundalih@aplcare.com

### PENDIDIKAN:

1. SDL Ir H Djuanda, Sukabumi Lulus 1988
2. SMP Negeri 1, Sukabumi Lulus 1991
3. SMA Negeri 1, Sukabumi Lulus 1994
4. D3 Instrumentasi Elektronika, Universitas Padjadjaran Bandung Lulus 1997
5. S1 Teknik Elektro, Universitas Darma Persada Jakarta Lulus 2011

### PEKERJAAN:

1. PT. Aiwa Indonesia Sukabumi, 1998 ~ 2001, Quality Assurance Leader
2. PT Anugerah Pharmindo Lestari, 2001 ~ sekarang, Infrastructure/Logistic Officer